

Index, Volume 45, 1984

March

- 3 **PIN-FET Receiver for Fiber Optics**
S. A. Siegel and D. J. Channin
- 23 **The Effect of Carrier-Induced Index Depressions on Fundamental-Transverse-Mode Characteristics in DH Laser Structures**
D. Botez
- 33 **Low Expansion Porcelain Coated Copper-Clad Invar Substrates**
K. W. Hang, A. N. Prabhu, J. Andrus, S. M. Boardman and L. S. Onyshkevych
- 49 **A Novel Memory Device for VLSI E²PROM**
S. T. Hsu
- 58 **A Study of the Etching Kinetics of Low Carbon Steel Using the Ferric Perchlorate-Perchloric Acid System as a Model**
R. B. Maynard, J. J. Moscony, and M. H. Saunders
- 73 **Ferric Chloride Etching of Low Carbon Steels**
R. B. Maynard, J. J. Moscony, and M. H. Saunders
- 90 **Interaction with Metal Films on Glass: A New Method for Evaluating Solder Parameters**
S. Tosima, S. Harada, and E. O. Johnson
- 109 **Extending the Content and Expanding the Usefulness of the Simple Gaussian Lens Equations—Part 3-A**
L. T. Sachtleben

165 Patents

168 Authors

June

- 177 **Foreword to Special Issue on Reliability**
George L. Schnable
- 179 **Reliability Characterization of High-Speed CMOS Logic ICs**
S. Gottesfeld and L. Gibbons
- 194 **Dielectric Integrity of Gate Oxides in SOS Devices**
R. K. Smeltzer and C. W. Benyon, Jr.
- 230 **Reliability of CMOS/SOS Integrated Circuits**
H. Veloric, M. P. Dugan, W. Morris, R. Denning, and G. Schnable
- 249 **Reliability of Plastic-Encapsulated Integrated Circuits**
L. J. Gallace and M. Rosenfield
- 278 **Moisture Control in Hermetic Leadless Chip Carriers with Silver-Epoxy Die-Attach Adhesive**
D. R. Carley, R. W. Nearhoof, and R. Denning
- 291 **Electrostatic Discharge: Mechanisms, Protection Techniques, and Effects on Integrated Circuit Reliability**
L. R. Avery

- 303 **Reliability in Communication Satellites**
Vincent J. Mancino and Walter J. Slusark, Jr.

326 **Patents**

329 **Authors**

September

- 337 **Adherence of Phosphor Screens**
S. Larach and J. E. McGowan
- 379 **Operating Mechanism of the One-Piece Cathode**
K. T. Chiang and J. J. Maley
- 397 **A Contour Deformation Model of Capacitance VideoDisc Signal Pickup**
P. D. Southgate
- 421 **Some Applications of z-Transforms and State Variables to Feedback Shift Registers**
Harry Urkowitz
- 449 **Image Formation in Contact-Printed PMMA Resist Sublayers**
L. K. White and D. Meyerhofer
- 461 **An Analytical Study of the Winding Harmonics of a Saddle Deflection Coil**
Basab B. Dasgupta
- 472 **Extending the Content and Expanding the Usefulness of the Simple Gaussian Lens Equations—Part 3-B**
L. T. Sachtleben
- 545 **Patents**
- 548 **Authors**

December

- 555 **Introduction**
M. Nowogrodzki and L. C. Upadhyayula
- 557 **Advanced Applications and Solid-State Power Sources for Millimeter-Wave Systems**
Glenn R. Thoren
- 579 **Millimeter-Wave Monolithic Passive Circuit Components**
S. C. Binari, R. E. Neidert, G. Kelner, and J. B. Bocs
- 587 **Silicon Technology for Millimeter-Wave Monolithic Circuits**
Paul J. Stabile and Arye Rosen
- 606 **A GaAs Power FET Suitable for Monolithic Integration, with Laser-Processed Gate and Drain Via Connections**
R. L. Camisa, G. C. Taylor, F. P. Cuomo, W. F. Reichert, and R. Brown
- 619 **Advances in the Design of Solid-State Power Amplifiers for Satellite Communications**
B. R. Dornan, M. T. Cummings, and F. J. McGinty
- 631 **Communication Receivers for Satellites—A Review**
H. B. Goldberg and S. S. Dhillon

- 651 **A 14-GHz Cooled Low-Noise GaAs FET Amplifier for Communication Satellite Application**
G. R. Busacca, P. A. Goldgeier, H. B. Goldberg, M. Noyes, and A. Chuchra
- 670 **20-GHz Lumped-Element GaAs FET Driver Amplifier**
Shabbir S. Mochalla and Donald E. Aubert
- 681 **Limiting Amplifier for Instantaneous Frequency Measuring System**
Robert E. Askew
- 688 **Patents**
- 692 **Authors**
- 701 **Index, Volume 45, 1984**

Index to Authors, Volume 45, 1984

- J. Andrus Low Expansion Porcelain Coated Copper-Clad Invar Substrates, March, p. 33
- R. E. Askew Limiting Amplifier for Instantaneous Frequency Measuring System, December, p. 681
- D. E. Aubert 20-GHz Lumped-Element GaAs FET Driver Amplifier, December, p. 670
- L. R. Avery Electrostatic Discharge: Mechanisms, Protection Techniques, and Effects on Integrated Circuit Reliability, June, p. 291
- C. W. Benyon, Jr. Dielectric Integrity of Gate Oxides in SOS Devices, June, p. 194
- S. C. Binari Millimeter-Wave Monolithic Passive Circuit Components, December, p. 579
- S. M. Boardman Low Expansion Porcelain Coated Copper-Clad Invar Substrates, March, p. 33
- J. B. Boos Millimeter-Wave Monolithic Passive Circuit Components, December, p. 579
- D. Botez The Effect of Carrier-Induced Index Depressions on Fundamental-Transverse-Mode Characteristics in DH Laser Structures, March, p. 23
- R. Brown A GaAs Power FET Suitable for Monolithic Integration, with Laser-Processed Gate and Drain Via Connections, December, p. 606
- G. R. Busacca A 14-GHz Cooled Low-Noise GaAs FET Amplifier for Communication Satellite Application, December, p. 651
- R. L. Camisa A GaAs Power FET Suitable for Monolithic Integration, with Laser-Processed Gate and Drain Via Connections, December, p. 606
- D. R. Carley Moisture Control in Hermetic Leadless Chip Carriers with Silver-Epoxy Die-Attach Adhesive, June, p. 278
- D. J. Channin PIN-FET Receiver for Fiber Optics, March, p. 3
- K. T. Chiang Operating Mechanism of the One-Piece Cathode, September, p. 379
- A. Chuchra A 14-GHz Cooled Low-Noise GaAs FET Amplifier for Communication Satellite Application, December, p. 651
- M. T. Cummings Advances in the Design of Solid-State Power Amplifiers for Satellite Communications, December, p. 619
- F. P. Cuomo A GaAs Power FET Suitable for Monolithic Integration, with Laser-Processed Gate and Drain Via Connections, December, p. 606
- B. B. Dasgupta An Analytical Study of the Winding Harmonics of a Saddle Deflection Coil, September, p. 461
- R. Denning Reliability of CMOS/SOS Integrated Circuits, June, p. 230
—Moisture Control in Hermetic Leadless Chip Carriers with Silver-Epoxy Die-Attach Adhesive, June, p. 278
- S. S. Dhillon Communication Receivers for Satellites—A Review, December, p. 631
- B. R. Dornan Advances in the Design of Solid-State Power Amplifiers for Satellite Communications, December, p. 619
- M. P. Dugan Reliability of CMOS/SOS Integrated Circuits, June, p. 230
- L. J. Gallace Reliability of Plastic-Encapsulated Integrated Circuits, June, p. 249
- L. Gibbons Reliability Characterization of High-Speed CMOS Logic ICs, June, p. 179
- H. B. Goldberg Communication Receivers for Satellites—A Review, December, p. 631
—A 14-GHz Cooled Low-Noise GaAs FET Amplifier for Communication Satellite Application, December, p. 651

- P. A. Goldgeier A 14-GHz Cooled Low-Noise GaAs FET Amplifier for Communication Satellite Application, December, p. 651
- S. Gottesfeld Reliability Characterization of High-Speed CMOS Logic ICs, June, p. 179
- K. W. Hang Low Expansion Porcelain Coated Copper-Clad Invar Substrates, March, p. 33
- S. Harada Interaction with Metal Films on Glass: A New Method for Evaluating Solder Parameters, March, p. 90
- S. T. Hsu A Novel Memory Device for VLSI E²PROM, March, p. 49
- E. O. Johnson Interaction with Metal Films on Glass: A New Method for Evaluating Solder Parameters, March, p. 90
- G. Keiner Millimeter-Wave Monolithic Passive Circuit Components, December, p. 579
- S. Larach Adherence of Phosphor Screens, September, p. 337
- J. J. Maley Operating Mechanism of the One-Piece Cathode, September, p. 379
- V. J. Mancino Reliability in Communications Satellites, June, p. 303
- R. B. Maynard A Study of the Etching Kinetics of Low Carbon Steel Using the Ferric Perchlorate-Perchloric Acid System as a Model, March, p. 58
- Ferric Chloride Etching of Low Carbon Steels, March, p. 73
- F. J. McGinty Advances in the Design of Solid-State Power Amplifiers for Satellite Communications, December, p. 619
- J. E. McGowan Adherence of Phosphor Screens, September, p. 337
- D. Meyerhofer Image Formation in Contact-Printed PMMA Resist Sublayers, September, p. 449
- S. S. Moochalla 20-GHz Lumped Element GaAs FET Driver Amplifier, December, p. 670
- W. Morris Reliability of CMOS/SOS Integrated Circuits, June, p. 230
- J. J. Moscony A Study of the Etching Kinetics of Low Carbon Steel Using the Ferric Perchlorate-Perchloric Acid System as a Model, March, p. 58
- Ferric Chloride Etching of Low Carbon Steels, March, p. 73
- R. W. Nearhoof Moisture Control in Hermetic Leadless Chip Carriers with Silver-Epoxy Die-Attach Adhesive, June, p. 278
- R. E. Neidert Millimeter-Wave Monolithic Passive Circuit Components, December, p. 579
- M. Nowogrodzki Introduction, December, p. 555
- M. Noyes A 14-GHz Cooled Low-Noise GaAs FET Amplifier for Communication Satellite Application, December, p. 651
- L. S. Onyshevych Low Expansion Porcelain Coated Copper-Clad Invar Substrates, March, p. 33
- A. N. Prabhu Low Expansion Porcelain Coated Copper-Clad Invar Substrates, March, p. 33
- W. F. Reichert A GaAs Power FET Suitable for Monolithic Integration, with Laser-Processed Gate and Drain Via Connections, December, p. 606
- A. Rosen Silicon Technology for Millimeter-Wave Monolithic Circuits, December, p. 587
- M. Rosenfield Reliability of Plastic-Encapsulated Integrated Circuits, June, p. 249
- L. T. Sechtleben Extending the Content and Expanding the Usefulness of the Simple Gaussian Lens Equations—Part 3-A, March, p. 109
- Extending the Content and Expanding the Usefulness of the Simple Gaussian Lens Equations—Part 3-B, September, p. 472
- M. H. Saunders A Study of the Etching Kinetics of Low Carbon Steel Using the Ferric Perchlorate-Perchloric Acid System as a Model, March, p. 58
- Ferric Chloride Etching of Low Carbon Steels, March, p. 73
- G. L. Schnable Foreword to Special Issue on Reliability, June, p. 177
- Reliability of CMOS/SOS Integrated Circuits, June, p. 230
- S. A. Siegel PIN-FET Receiver for Fiber Optics, March, p. 3
- W. J. Slusark, Jr. Reliability in Communications Satellites, June, p. 303
- R. K. Smeltzer Dielectric Integrity of Gate Oxides in SOS Devices, June, p. 194
- P. D. Southgate A Contour Deformation Model of Capacitance VideoDisc Signal Pickup, September, p. 397
- P. J. Stable Silicon Technology for Millimeter-Wave Monolithic Circuits, December, p. 587
- G. C. Taylor A GaAs Power FET Suitable for Monolithic Integration, with Laser-Processed Gate and Drain Via Connections, December, p. 606
- G. R. Thoren Advanced Applications and Solid-State Power Sources for Millimeter-Wave Systems, December, p. 557
- S. Tosima Interaction with Metal Films on Glass: A New Method for Evaluating Solder Parameters, March, p. 90
- L. C. Upadhyayula Introduction, December, p. 555
- H. Urkowitz Some Applications of z-Transforms and State Variables to Feedback Shift Registers, September, p. 421
- H. Veloric Reliability of CMOS/SOS Integrated Circuits, June, p. 230
- L. K. White Image Formation in Contact-Printed PMMA Resist Sublayers, September, p. 449

